



SANYO Semiconductors

DATA SHEET

LB8652T — Monolithic Digital IC

Driver for Digital Still Cameras

Features

- Actuator driver for digital cameras embedded in one chip. (Not supported synchronous driving.)
 - (1) Saturation output for AF - Stepping motor (2 phase, 1-2 phase excitation possible)
 - (2) Constant current control output for SH
- Quick charge and quick discharge circuitry allow the stabilization of response speeds.
- Input port 1 allows shutter close control.
- When shutter opening control, open-loop constant current control is possible.
 - (3) Saturation output for AE - VCM or stepping motor can be used. (2 phase, 1-2 phase excitation possible)
 - (4) ZOOM (lens barrel) - Constant voltage DC motor driver (Normal evolution/Reverse evolution/Brake)
Or saturation output stepping motor (2 phase, 1-2 phase excitation possible)

- Applications of various actuators possible.

	SH	AE	AF	ZOOM
Application Example 1	VCM	VCM	STM	DCM
Application Example 2	VCM	VCM	STM	STM
Application Example 3	VCM	STM	STM	DCM

- No standby current consumption (or zero).
- 2 system power source (VB : for DC motor, VCC : others)
- Low saturation output
- Built-in thermal protection circuitry
- Small, thin package

Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum Power Source Voltage	VB max	VB	10.5	V
	VCC max	VCC	10.5	
Maximum Applied Input Voltage	V _{IN} max	MD1 to 3, IN1 to 4	10.5	V
Maximum Applied Output Voltage	V _{OUT} max	OUT1 to 8	10.5	V

Continued on next page.

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Parameter	Symbol	Conditions	Ratings	Unit
Maximum Output Current 1	$I_{O\ max1}$	OUT1	400	mA
Maximum Output Current 2	$I_{O\ max2}$	OUT2, 3, OUT5 to 7	600	mA
Maximum Output Current 3	$I_{O\ max3}$	OUT4, OUT8	800	mA
Allowable Power Dissipation	$P_d\ max1$	Substrate mounting (*1)	800	mW
Operating Temperature	T_{opr1}		-20 to +80	°C
Storage Temperature	T_{stg}		-55 to +150	°C

(*1) Standard mounting substrate : 76.1mm×114.3mm×1.6mm glass epoxy resin

Allowable Operating Range at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Source Voltage Range	V_B	(*2)	2.0 to 10	V
	V_{CC}		2.0 to 10	
Input Pin High Level Voltage	V_{INH}	MD1 to 3, IN1 to 4	1.8 to 10	V
Input Pin Low Level Voltage	V_{INL}	MD1 to 3, IN1 to 4	-0.3 to 0.4	V
Constant Voltage Setting Input Range	V_{OC}	VC	0.8 to 2.0	V

(*2) No restriction on priority among applied voltages of V_B (Battery power source),

V_{CC} (step-up power source) and V_{IN} (CPU power source).

Example 1 : $V_B = 3.3\text{V}$, $V_{CC} = 4.0\text{V}$, $V_{IN} = 5.0\text{V}$

Example 2 : $V_B = 3.3\text{V}$, $V_{IN} = 5.0\text{V}$

Electrical Characteristics at $T_a = 25^\circ\text{C}$, $V_B = V_{CC} = 3\text{V}$, $R_f = 1\Omega$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Standby Current Consumption	I_{CC0}	$V_B = V_{CC} = 8.0\text{V}$ MD1 to 3, IN1 to 4 = L		0.1	5.0	μA
V_{CC} Operating Current Consumption	I_{CC1}	AF mode IN1, 3 = H (2 phase excitation)		24	32	mA
	I_{CC2}	AF mode IN3 = H (1 phase excitation)		14	21	
	I_{CC3}	SH mode IN1 = L		42	54	
	I_{CC4}	SH mode IN1 = H RILM = 2k Ω		18	24	
VB Operating Current Consumption	I_B	DC-ZOOM mode IN3 = H		7	15	mA
Reference Voltage	V_{ref}	$I_{ref} = -1\text{mA}$	1.74	1.8	1.86	V
Reference Voltage start-up time	T_r	Design guaranteed		0.5	2.0	μs
Input Pin Current	I_{IN}	$V_{IN} = 5.0\text{V}$		70	90	μA
Overheat Protection Operation Temperature	THD	Design guaranteed (*3)	160	180	200	°C
[Stepping motor driver for AF] (OUT2 to 3, OUT6 to 7)						
Output Saturation Voltage 1	V_{SAT1}	$V_{CC} = 3.3\text{V}$, $I_O = 0.2\text{A}$ (upper and lower)	0.15	0.25	0.40	V
[AE driver] (OUT5 to 6)						
Output Saturation Voltage 2	V_{SAT2}	$V_{CC} = 3.3\text{V}$, $I_O = 0.2\text{A}$ (upper and lower)	0.15	0.25	0.40	V
[SH driver] (OUT1 to 2)						
Output Constant Current 1	I_{O1}	OUT2→OUT1 $V_{CC} = 3.0$ to 3.7V , $R_f = 1\Omega$	194	206	218	mA
Output Constant Current 2	I_{O2}	OUT1→OUT2 $V_{CC} = 3.3\text{V}$ RILM = 1.6k Ω	130	160	190	
Output Saturation Voltage 3	V_{SAT3}	OUT2→OUT1 $V_{CC} = 3.3\text{V}$, $I_O = 0.2\text{A}$ (upper and lower)	0.15	0.25	0.40	V
[DC motor driver for ZOOM] (OUT4 to 8)						
Output Constant Voltage	V_O	$V_B = 3.0$ to 3.7V , $V_C = 1\text{V}$	2.38	2.5	2.62	V
Output Saturation Voltage 4	V_{SAT4}	$V_B = 3.3\text{V}$, $I_O = 0.3\text{A}$ (upper and lower)	0.2	0.3	0.45	V
Output Saturation Voltage 5	V_{SAT5}	$V_B = 3.3\text{V}$, $I_O = 0.3\text{A}$ (upper)	0.1	0.18	0.25	V

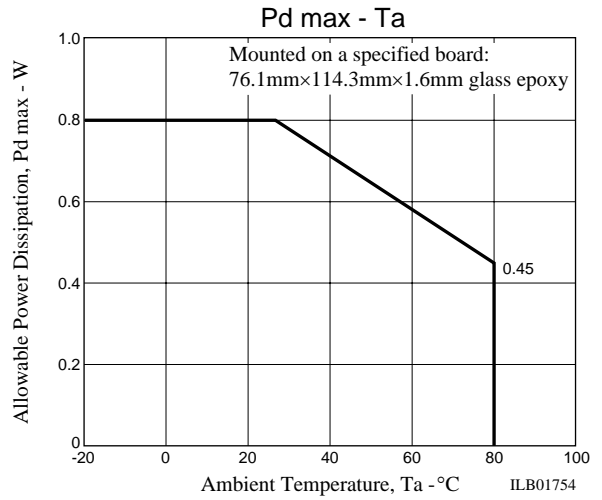
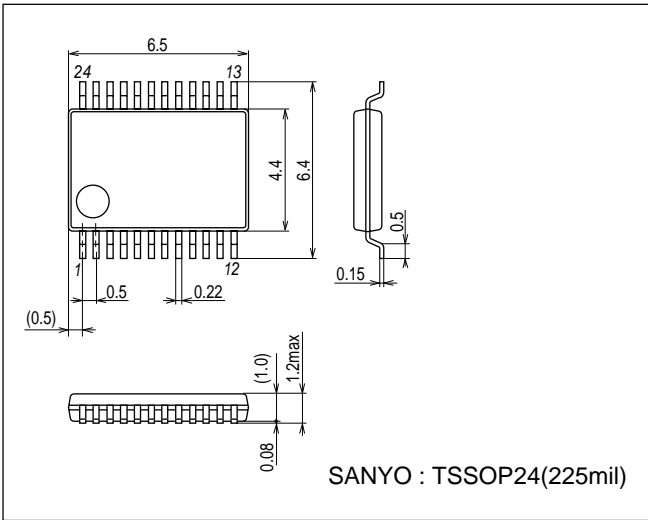
(*3) For the characteristic within the guaranteed temperature range, shipping check is performed at $T_a = 25^\circ\text{C}$.

For all temperature range, it is design guaranteed.

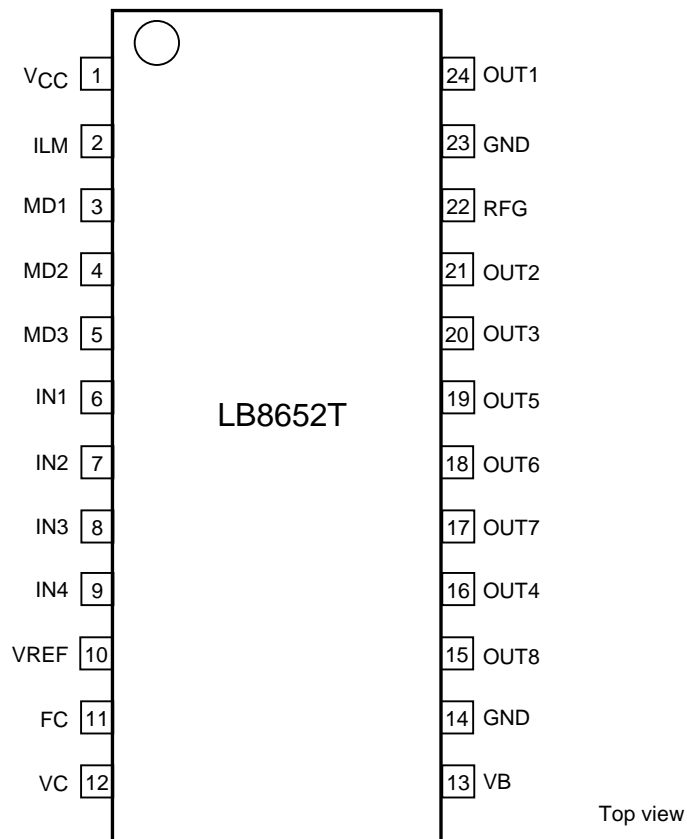
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Package Dimensions

unit : mm (typ)
3260A



Pin Assignment



(Note) Both 2 pins are connected to GND pin.

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True Value Table

Input							Output								Mode	
MD1	MD2	MD3	IN1	IN2	IN3	IN4	OUT1	OUT2	OUT3	OUT4	OUT5	OUT6	OUT7	OUT8		
L	L	L	L	L	L	L	-	-	-	-	-	-	-	-	Standby (0μA)	
L	L	H	L	*	*	*	<u>L</u>	H	-	-	-	-	-	-	SH (VCM)	
			H	*	*	*	H	L	-	-	-	-	-	-		
L	H	H	L	L			-	-	-	-			-	-	AE (VCM) or (STEP3)	
			L	H			-	-	L	H			-	-		
			H	L			-	-	H	L			-	-		
			H	H			-	-	-	-			-	-		
					L	L	-	-			-	-	-	-		
					L	H	-	-			L	H	-	-		
					H	L	-	-			H	L	-	-		
					H	H	-	-			-	-	-	-		
H	L	L	*	*	L	L	-	-	-	-	-	-	-	-	ZOOM (DC)	
			*	*	L	H	-	-	-	<u>L</u>	-	-	-	<u>H</u>		
			*	*	H	L	-	-	-	<u>H</u>	-	-	-	<u>L</u>		
			*	*	H	H	-	-	-	<u>H</u>	-	-	-	<u>H</u>		
H	H	L	L	L			-	-	-	-			-	-	AF (STEP1)	
			L	H			-	L	H	-			-	-		
			H	L			-	H	L	-			-	-		
			H	H			-	-	-	-			-	-		
					L	L	-	-			-	-	-	-		
					L	H	-	-			-	-	L	H		-
					H	L	-	-			-	-	H	L		-
					H	H	-	-			-	-	-	-		-
H	L	H	L	L			-	-	-	-			-	-	ZOOM (STEP2)	
			L	H			-	-	L	H			-	-		
			H	L			-	-	H	L			-	-		
			H	H			-	-	-	-			-	-		
					L	L	-	-			-	-	-	-		
					L	H	-	-			-	-	L	H		
					H	L	-	-			-	-	H	L		
					H	H	-	-			-	-	-	-		
L	H	L	*	*	*	*	-	-	-	-	-	-	-	Ignore		
H	H	H	*	*	*	*	-	-	-	-	-	-	-			

(*) : Don't care.

(-) : Output OFF

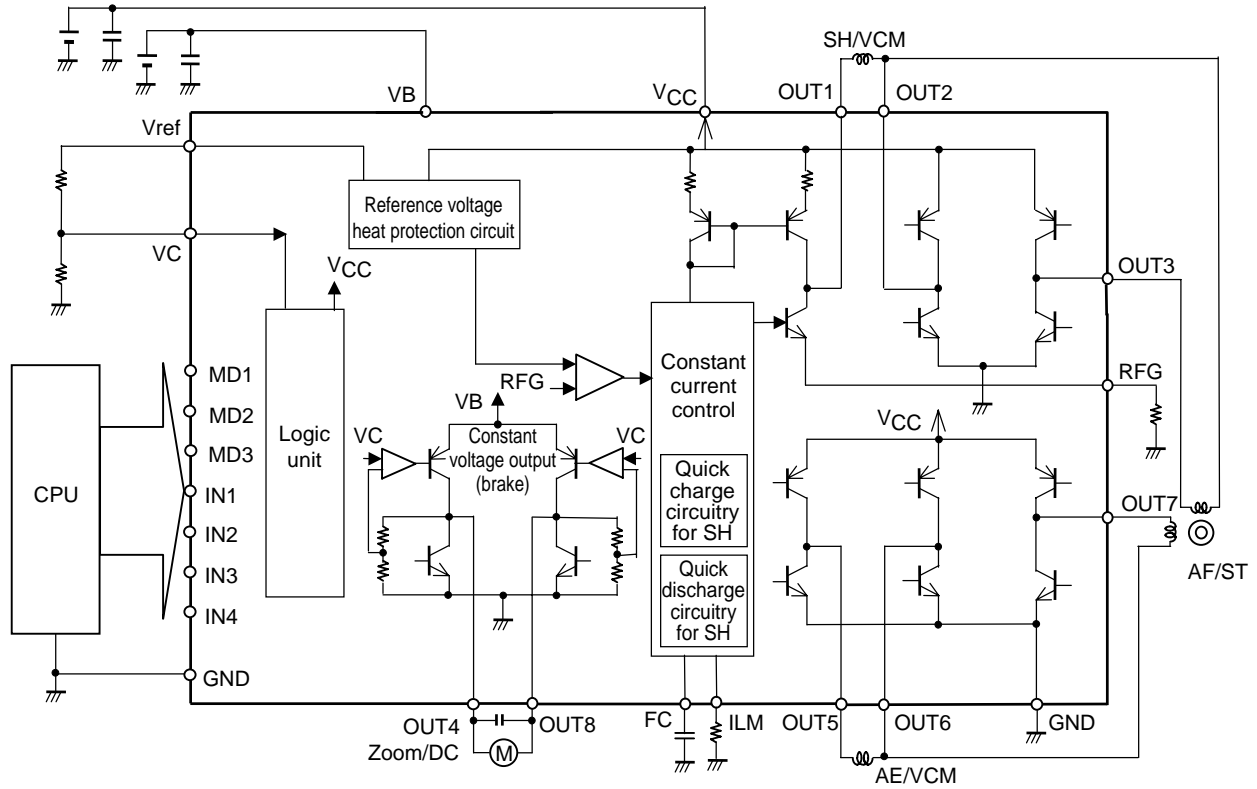
(H) : Constant voltage output is 2.5 time the VC pin applied voltage.

(L) : Constant current output is (IC pin applied voltage÷RFG resistor current).

Note : When the current flows from OUT1 to OUT2, easy constant current output function is ON.

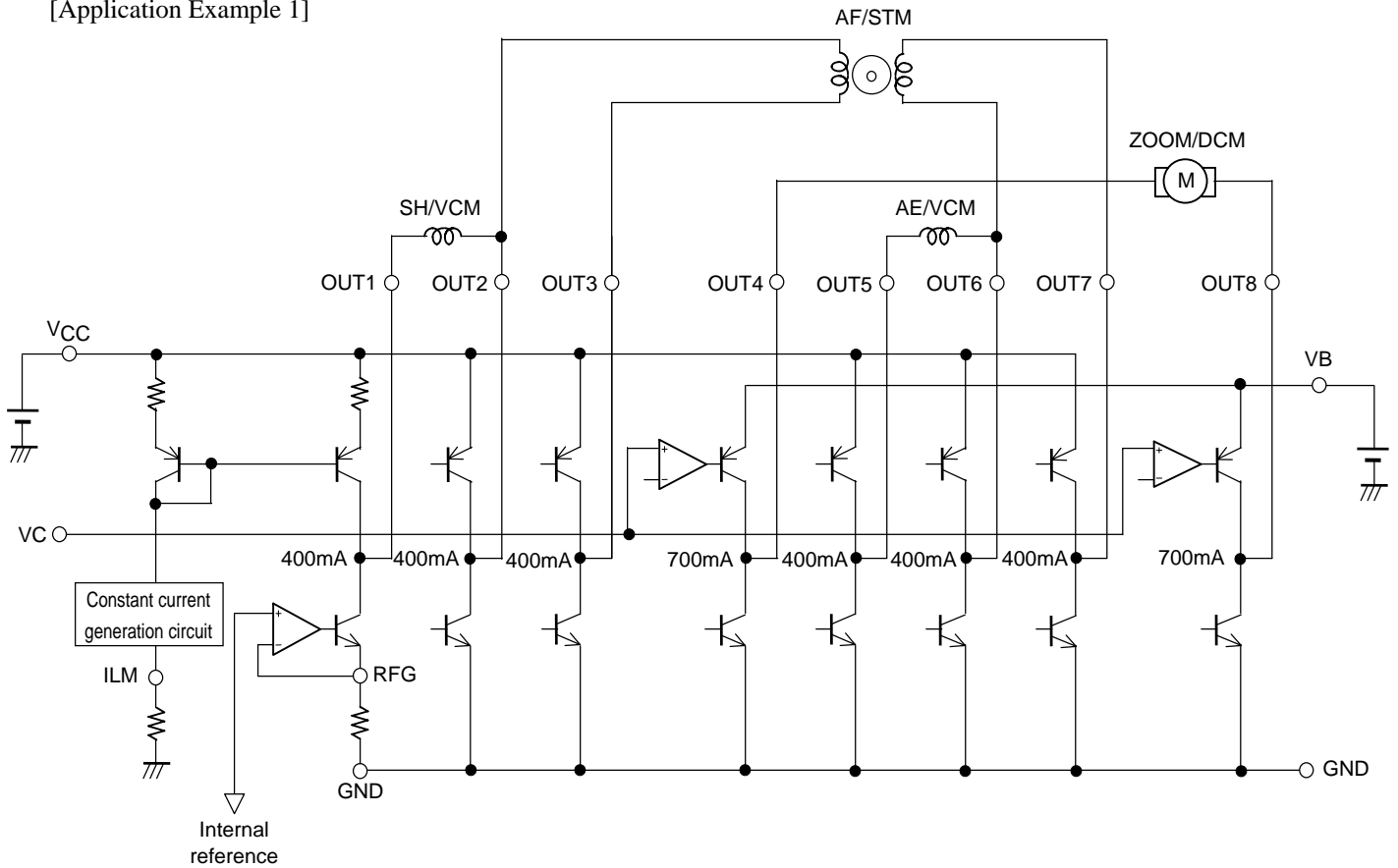
The output current is controlled by the resistance value connected between the ILM pin and GND.

Block Diagram



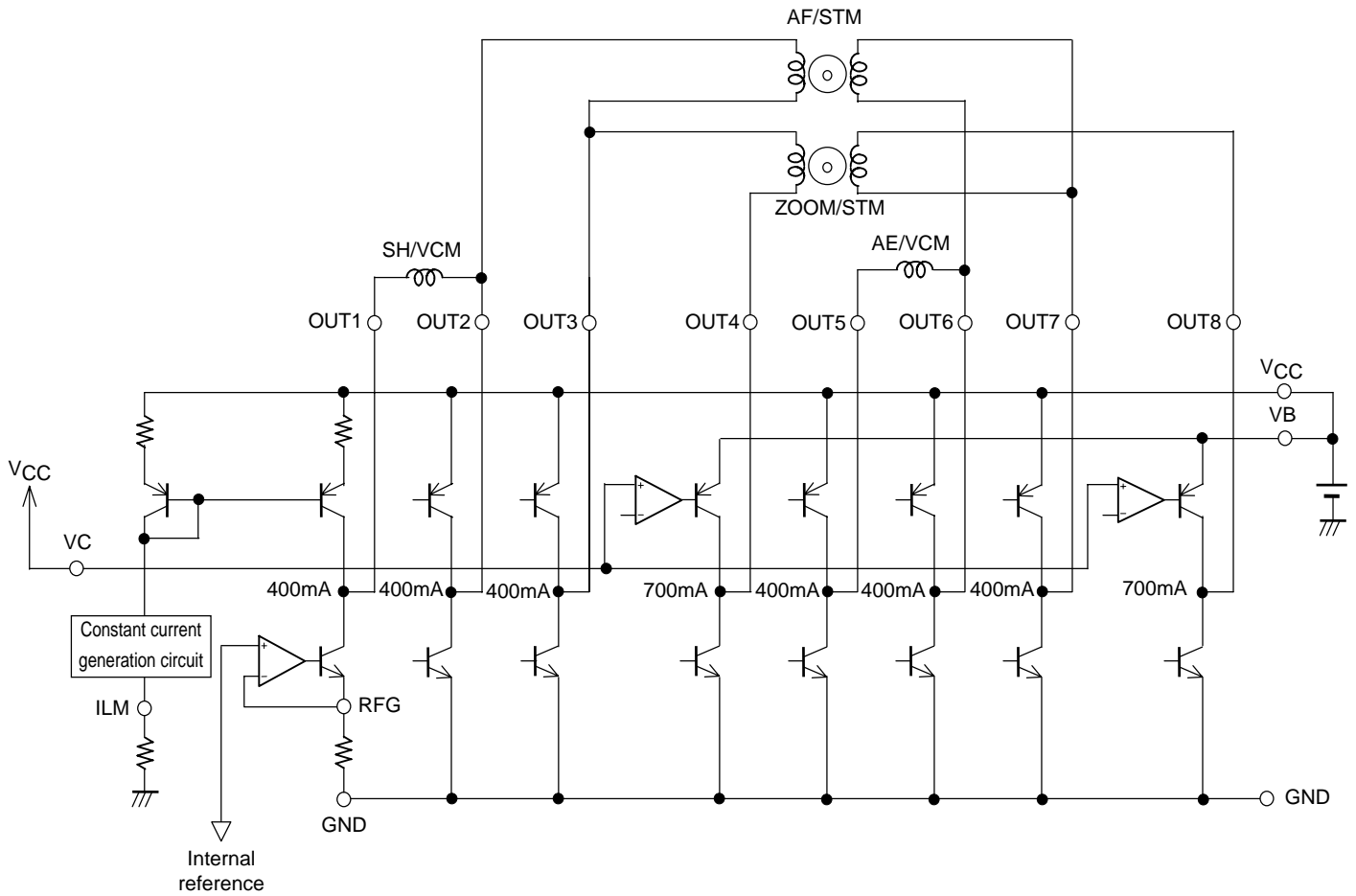
Application Circuit Diagram

[Application Example 1]

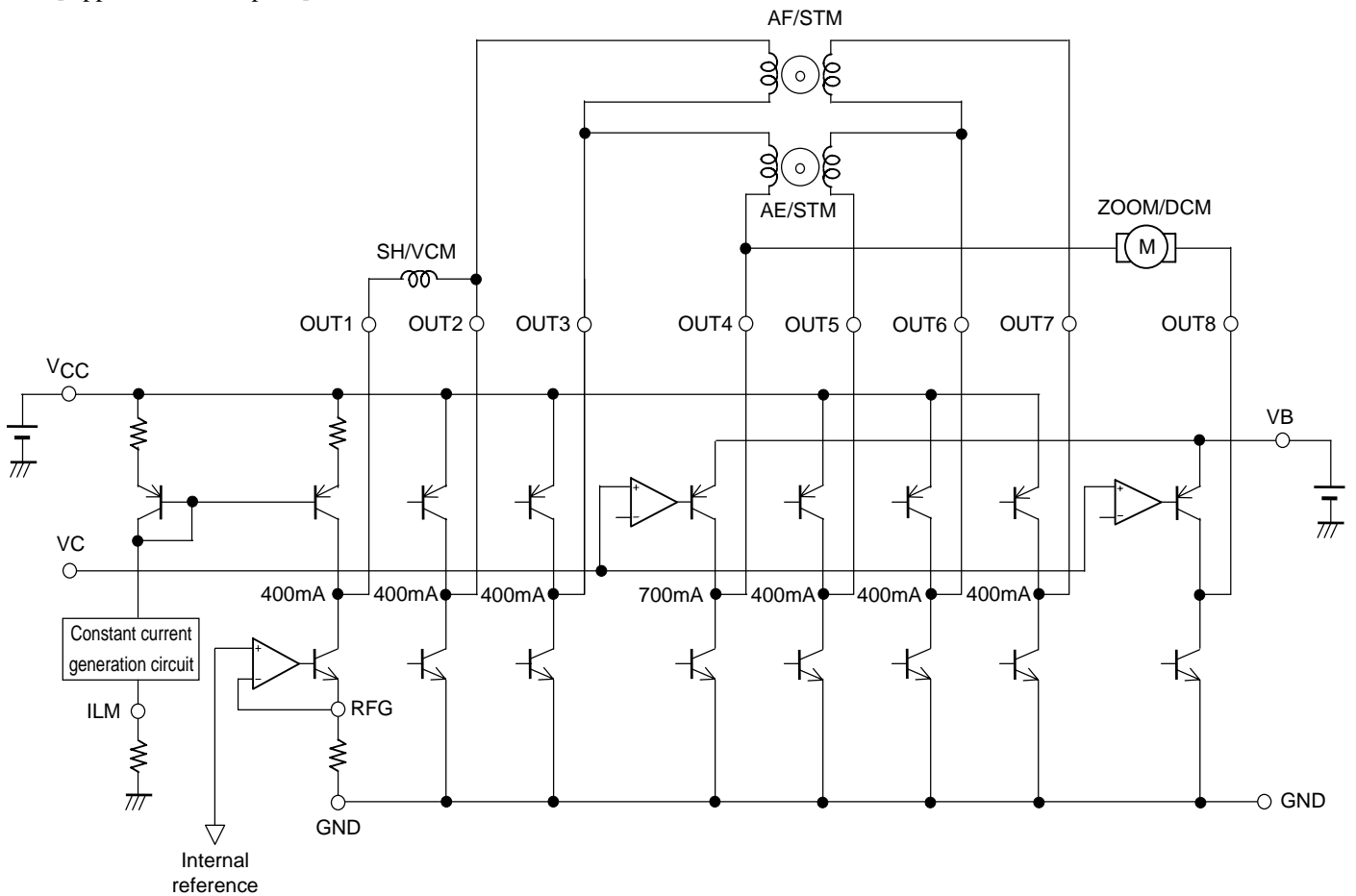


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[Application Example 2]



[Application Example 3]



Points to Take into Consideration When Designing**(1) For shutter control Constant current setting (RFG, OUT1, OUT2)**

The constant current when flowing the current from OUT2 to OUT1 can be specified by a resistor connected between RFG and GND. The reference voltage is generated in the IC and it is approximately 0.21V. The voltage is controlled in such a way so that the voltage generated at the resistor used for current detection connected between RFG and GND would be equal to this voltage.

The formula for calculating the output current is as given below. In addition, as a fundamental setting, it is designed so that the approx. 200mA would flow through the coil when RFG resistor is connected with 1Ω.

(Current flows from OUT2 to OUT1)

$$= 0.21V \div (\text{Resistance between RFG and GND} + 0.05\Omega) - (\text{Drive current of output Tr})$$

This 0.05Ω is for a common impedance of the output Tr emitter which drives constant current in the RFG pin and the sensing wiring for the constant current control amplifier.

Also, the drive current of output Tr is equal to 1/hfe (a 80th to 200th part approx.) of the coil current.

The constant current flowed from OUT2 to OUT1 is more accurate than that flowed from OUT1 to OUT2.

Therefore make sure to use this method for shutter closing drive.

(2) For shutter control Open-loop constant current control setting (ILM, OUT1, OUT2)

In order to prevent the high-current flowing when shutter opening, the output current control circuit is implemented for current flowing from OUT1 to OUT2. The constant current when flowing the current from OUT1 to OUT2 can be specified by a resistor connected between ILM and GND.

The formula for calculating the output current is as given below.

$$(\text{Current flows from OUT1 to OUT2}) = 1.36V \div (\text{Resistance between ILM and GND}) \times 200 \text{ approx.}$$

Due to open-loop control by which feedback signals are not sent, the accuracy of constant current is relatively inferior. It is used for shutter opening drive.

(3) Phase compensation capacitor (FC)

See and check the capacitor value for FC pin between 0.0015 to 0.033μF. Choose a capacitance value which does not cause oscillation problems for output. In particular, when a coil with large inductance is used, it is necessary to choose a sufficiently large capacitance.

(4) Constant voltage control Oscillation-stopping capacitor (OUT4, OUT8)

When controlling the constant voltages, it is necessary to place capacitors between the OUT pins to stop oscillation. See and check the capacitance value between 0.01μF to 0.1μF. Choose a capacitance value which does not cause oscillation problems for output.

When driving at saturation, there is no need for such oscillation-stopping capacitors.

(5) GND wiring and power line capacitors : (GND×2, VCC, VB)

Connect GND (2 places) near the IC, and place the capacitors as close as possible to each of the power pins.

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